



PRODUCT

High Temperature Polyimide Masking Dots

FEATURES

- High temperature polyimide masking dots are ideal for masking gold fingers of printed circuit boards during wave solder or solder dip process, as well as for solder wave masking and electrical insulation.
- These high temperature dots are a polyimide, pressure sensitive, adhesive tape with silicon resin, which shows excellent dielectric insulation properties, high heat resistance and excellent solvent resistance. These properties result in a tape with remarkable dimensional stability and excellent electrical and physical properties over a wide range of temperatures.
- High temperature polyimide masking dots are composed of a polyimide film masking dots with silicone adhesive on a clear easy release liner.
- High temperature polyimide masking dots are both flame and chemical resistant.
- This product is neither corrosive nor ozone depleting

PRODUCT CODE	DESCRIPTION	SIZE (mm)	QUANTITY
053-1000	High temperature Masking Polyimide Dots	6	Per Roll of 1,000
053-1001	High temperature Masking Polyimide Dots	8	Per Roll of 1,000
053-1002	High temperature Masking Polyimide Dots	10	Per Roll of 1,000
053-1003	High temperature Masking Polyimide Dots	12	Per Roll of 1,000

To request a quotation or for more information, please call **+1 512-580-4220** email sales@antistat.com or visit www.antistat.com

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TECHNICAL SPECIFICATIONS

	DIN VALUE	ASTM VALUE
Structure	Silicon Adhesive/Polyimide Film	
Base Film Thickness	0.025mm	1.0Mil
Total Thickness	0.070mm	2.8Mil
Peel Strength	2.7N/cm	25Oz/In
Tensile Strength	40N/cm	22lbs/In
Elongation	50%	50%
Heat Resistance (Short Term)	290°C	554°F
Heat Resistance	230°C	446°F
Appearance	Amber	Amber

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